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1. General description

The UBA2035 is a high voltage monolithic Integrated Circuit (IC) manufactured in a High Voltage Silicon On Insulator (HVSOI) process. This circuit is designed for driving MOSFETs in a full bridge configuration. In addition, it features a disable function, an internal adjustable oscillator and an external clock input function with a high-voltage level shifter for driving the bridge. To guarantee an accurate 50 % duty cycle, the oscillator signal can be passed through a divider before being fed to the output drivers.

The UBA2035 is especially suitable for High Intensity Discharge (HID) lamp drivers for projectors and general lighting applications for which a small non-overlap time is required.

2. Features

- Full bridge driver circuit
- Integrated bootstrap diodes
- 550 V series regulator input to make the internal supply
- 550 V maximum bridge voltage
- Accurate bridge disable function
- Input for start-up delay
- Adjustable oscillator frequency
- Selectable frequency divider
- Predefined bridge position during start-up
- A fixed non-overlap (< 200 ns)

3. Applications

- The UBA2035 can drive (via the power MOSFETs) any kind of load in a full bridge configuration
- The circuit is especially designed as a commutator controller for high intensity discharge lamps in projectors and general lighting applications

4. Ordering information

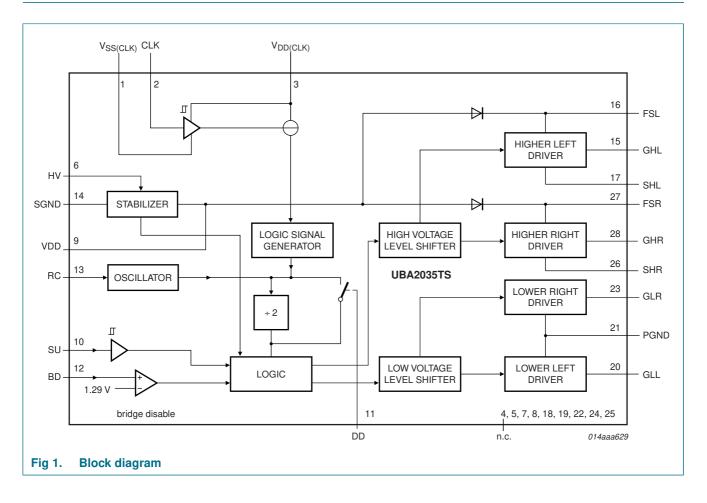
Table 1.Ordering information

Type number	Package	Package			
	Name	Description	Version		
UBA2035TS	SSOP28	plastic shrink small outline package; 28 leads; body width 5.3 mm	SOT341-1		



HF Full bridge control IC for HID lighting

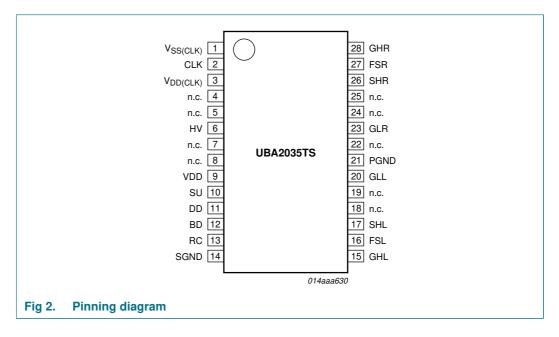
5. Block diagram



UBA2035 1

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2.	Pin description	
Symbol	Pin UBA2035TS	Description
V _{SS(CLK)}	1	negative supply voltage for logic oscillator input
CLK	2	oscillator input
V _{DD(CLK)}	3	positive supply voltage for logic oscillator input
n.c.	4	not connected
n.c.	5	not connected
HV	6	high voltage supply input for internal series regulator
n.c.	7	not connected
n.c.	8	not connected
VDD	9	internal low voltage supply
SU	10	input for start-up delay
DD	11	input for divider disable
BD	12	input for bridge disable
RC	13	RC input for internal oscillator
SGND	14	signal ground
GHL	15	gate driver output for upper left MOSFET
FSL	16	floating supply left
SHL	17	source upper left MOSFET
n.c.	18	not connected

Table 2.	Pin descriptionc	ontinued
Symbol	Pin UBA2035TS	Description
n.c.	19	not connected
GLL	20	gate driver output for lower left MOSFET
PGND	21	power ground
n.c.	22	not connected
GLR	23	gate driver output for lower right MOSFET
n.c.	24	not connected
n.c.	25	not connected
SHR	26	source upper right MOSFET
FSR	27	floating supply right
GHR	28	gate driver upper right MOSFET

7. Functional description

7.1 Supply voltage

The UBA2035 is powered by a supply voltage applied to pin HV, e.g., the supply voltage of the full bridge. The IC generates its own low supply voltage for its internal circuitry. Therefore an additional low voltage supply is not required. A capacitor has to be connected to pin VDD to obtain a ripple-free internal supply voltage. The circuit can also be powered by a low voltage supply directly applied to pin VDD. In this case pin HV should be connected to pin VDD or pin SGND. The maximum current that the internal series regulator can deliver, is temperature dependent. See Figure 3.

7.2 Start-up

With an increasing supply voltage the IC enters the start-up state i.e. the upper power transistors are set in off-state and the lower power transistors are switched on. During the start-up state the bootstrap capacitors are charged. The start-up state is defined until $V_{VDD} = V_{startup(VDD)}$ or $V_{HV} = V_{startup(HV)}$. The state of the outputs during the start-up phase is overruled by the bridge disable function.

7.3 Oscillation state

As soon as the supply voltage on pin VDD exceeds $V_{startup(VDD)}$ or the supply voltage on pin HV exceeds $V_{startup(HV)}$, the output voltage of the full bridge depends on the control signals on pins CLK, SU, DD and BD. This is listed in <u>Table 3</u>.

As soon as the supply voltage on pin VDD becomes lower than $V_{UVLO(VDD)}$ or the supply voltage on pin HV becomes lower than $V_{UVLO(HV)}$, the IC enters the start-up state again.

UBA2035 1

HF Full bridge control IC for HID lighting

Device state	BD	SU	DD	CLK	GHL	GHR	GLL	GLR
Start-up	1	-	-	-	0 (= V _{SHL})	$0 (= V_{SHR})$	$0 = V_{PGND}$	$0 (= V_{PGND})$
state	0	-	-	-	0 (= V _{SHL})	$0 (= V_{SHR})$	$1 (= V_{VDD})$	$1 (= V_{VDD})$
Oscillation	1	-	-	-	0 (= V _{SHL})	$0 (= V_{SHR})$	$0 (= V_{PGND})$	$0 (= V_{PGND})$
state	0	0	-	-	0 (= V _{SHL})	$0 (= V_{SHR})$	$1 (= V_{VDD})$	$1 (= V_{VDD})$
	0	1	1	1	0 (= V _{SHL})	1 (= V _{FSR})	1 (= V _{VDD})	$0 (= V_{PGND})$
	0	1	1	0	1 (= V _{FSL})	$0 (= V_{SHR})$	$0 (= V_{PGND})$	$1 (= V_{VDD})$
	0	1	0[1]	$1 \rightarrow 0^{[2]}$	GHL	GHR	GLL	GLR

Table 3. Driver

[1] If pin DD = 0 the bridge enters the state (oscillation state and pin BD = 0 and pin SU = 1) in the predefined position: V_{GHL} = V_{FSL}, V_{GLR} = V_{VDD}, V_{GLL} = V_{PGND} and V_{GHR} = V_{SHR}.

[2] Only if the level of pin CLK changes from logical 1 to 0, the level of outputs GHL, GHR, GLL and GLR changes.

If there is no external clock available, the internal oscillator can be used. The design equation for the bridge oscillator frequency is shown in Equation 1.

$$f_{bridge} = \frac{I}{K_{osc} \times R_{osc} \times C_{osc}}$$
(1)

 R_{osc} and C_{osc} are external components connected to the RC pin (R_{osc} connected to pin VDD and C_{osc} connected to pin SGND). In this situation the pins $V_{DD(CLK)}$, CLK, and $V_{SS(CLK)}$ can be connected to SGND.

The clock signal, either coming from pin RC or pin CLK, can be divided by two in order to obtain a 50 % duty cycle gate drive signal. This can be achieved by applying a voltage to the DD input lower than $V_{IL(DD)}$ (e.g. connect pin DD to pin SGND).

7.4 Non-overlap time

In the full bridge configuration the non-overlap time is defined as the time between turning off the two conducting MOSFETs and turning on the two other MOSFETs. The (very small) non-overlap time is internally fixed to t_{no} , which allows a HID system to operate with a very small phase angle between the load current and the full bridge voltage (pins SHL and SHR). This can be beneficial for HID systems in which the lamp is ignited via a resonance network.

7.5 Start-up delay

A simple resistor-capacitor (RC) filter (R between pin VDD and pin SU; C between pin SU and pin SGND) or a control signal from a processor can be used to create a start-up delay. This can be beneficial for those applications in which building up the high voltage takes more time. A start-up delay will ensure that the HID system will not start up before this high voltage has been reached.

7.6 Bridge disable

The bridge disable function can be used to switch off all MOSFETs as soon as the voltage on pin BD exceeds the bridge disable voltage V_{BD} . The bridge disable function overrules all the other states.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). All voltages are measured with respect to signal ground (pin 14); positive currents flow into the chip. The voltage ratings are valid provided other ratings are not violated.

$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Symbol	Parameter	Conditions	Min	Max	Unit
$\begin{split} \begin{tabular}{ c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	General					
Image storage temperature -55 +150 °C Voltages Voltage on pin VDD 0 14 V VypD voltage on pin VDD 0 550 V VstRL voltage on pin SHL with respect to PGND and SGND -3 +550 V VsHR voltage on pin SHR with respect to PGND and SGND -3 +550 V VFSL voltage on pin FSL with respect SHL 0 14 V VFSR voltage on pin GHL voltage on pin GHR VsH VsH VsH VFSL V VGHR voltage on pin GHR with respect SHR 0 14 V VGHR voltage on pin GHR VsH VsFL V VGHR voltage on pin GLR VsH VsH VsH VsH VgGND voltage on pin GLR VpGND VvDD V VgGND voltage on pin GLR voltage oil 4 V VgGND voltage pin CLK with respect to VsS(CLK)	T _{amb}	ambient temperature		-40	+125	°C
$V_{\text{VDD}} Voltage on pin VDD = 0 14 V V V V V V V V V V V V V V V V V V $	Tj	junction temperature		-40	+150	°C
Vyppvoltage on pin VDD014VVHVvoltage on pin HV0550VVSHLvoltage on pin SHLwith respect to PGND and SGND-3+550VVSHRvoltage on pin SHRwith respect to PGND and SGND-3+550VVFSLvoltage on pin FSLwith respect SHL014VVFSRvoltage on pin GHL014VVVGHLvoltage on pin GHLVsHLVsHLVFSLVVGHRvoltage on pin GLLVsHLVsHLVFSNVVGLLvoltage on pin GLRVFSNVvDDVVGLLvoltage on pin GLRVFSNVVVGLLvoltage on pin GLR-0.914VVpGNDvoltage on pin GLRVFSN05VVSICLK)CLK ground supply voltagewith respect to VSICLK)014VVpGNDvoltage on pin GLR-0.914VVVpGNDVoltagewith respect to VSICLK)014VVpGLK)CLK ground supply voltagewith respect to VSICLK)014VVpICLK)CLK supply voltagewith respect to VSICLK)014VVIinput voltagepins RC, SU, BD, and DD0VypDVSRslew ratepins SHL and SHR-4V/msESDVssiFSR, GHL, GHR, SHL, GHR, SHL, SHR-900VFSR, GHL	T _{stg}	storage temperature		-55	+150	°C
$V_{HV} = Voltage on pin HV = V = 0 + 550 = V = V_{SHL} = 0 + 550 = V = V_{SHL} = 0 + 550 = V = V_{SHR} = V_{OTTAGG ON Pin SHR} = 0 + 550 = V = V_{SHR} = V_{OTTAGG ON Pin SHR} = 0 + 14 = V = V_{SFR} = V_{SHR} = V_{S$	Voltages					
$ \begin{array}{c c c c c c } \begin{tabular}{ c c c c c } \label{eq:spectral} \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	V _{VDD}	voltage on pin VDD		0	14	V
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	V _{HV}	voltage on pin HV		0	550	V
$V_{FSL} voltage on pin FSL with respect SHL & 0 & 14 & V \\V_{FSR} voltage on pin FSR with respect SHR & 0 & 14 & V \\V_{GHL} voltage on pin GHL & V_{SHL} & V_{FSL} & V \\V_{GHR} voltage on pin GHR & V_{SHR} & V_{FSR} & V \\V_{GLL} voltage on pin GLR & V_{PGND} & V_{VDD} & V \\V_{GLR} voltage on pin GLR & V_{PGND} & V_{VDD} & V \\V_{SS(CLK)} & CLK ground supply voltage & with respect to V_{SS(CLK)} & 0 & 14 & V \\V_{DD(CLK)} & CLK supply voltage & with respect to V_{SS(CLK)} & 0 & 14 & V \\pin CLK; with respect to V_{SS(CLK)} & 0 & 14 & V \\pin SR & slew rate & pin SHL and SHR & - & 4 & V/ns \\Currents \\R_{osc} & oscillator resistance & connected between pins VDD and RC & V_{VDD} & V \\V_{ESD} & electrostatic discharge voltage \\V_{SS} & Human body model: & V_{SS(CLK)} & 100 & - & K\Omega \\\hlineV_{V} & V_{SS(CLK)} & V_{DD(CLK)}, V_{DD(CLK)}, CLK, FSL, \\FSR, GHL, GHR, SHL, SHR & - & 2 & KV \\\hlineMex & machine model; all pins & - & 2 & KV \\\hlineV_{RSD} & V_{RSD} \\\hlineV_{RSD} & V_{RSD} \\\hlineV_{RSD} & V_{RSD} \\\hlineV_{RSD} & V_{RSD} \\\hlineV_{RSD} & V_{RSD} &$	V _{SHL}	voltage on pin SHL	with respect to PGND and SGND	-3	+550	V
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	V _{SHR}	voltage on pin SHR	with respect to PGND and SGND	-3	+550	V
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	V _{FSL}	voltage on pin FSL	with respect SHL	0	14	V
$\begin{tabular}{ c c c c } \hline VGHR & Voltage on pin GHR & Voltage on pin GLL & V_{SHR} & V_{FSR} & V \\ \hline V_{GLL} & voltage on pin GLR & V_{PGND} & V_{VDD} & V \\ \hline V_{GLR} & voltage on pin GLR & V_{PGND} & V_{VDD} & V \\ \hline V_{PGND} & voltage on pin PGND & 0 & 5 & V \\ \hline V_{SS(CLK)} & CLK ground supply voltage & with respect to V_{SS(CLK)} & 0 & 14 & V \\ \hline V_{DD(CLK)} & CLK supply voltage & with respect to V_{SS(CLK)} & 0 & 14 & V \\ \hline V_{DD(CLK)} & CLK supply voltage & pin SHL and SHR & 0 & V_{VDD} & V \\ \hline V_{SSR} & slew rate & pins SHL and SHR & - & 4 & V/ns \\ \hline Currents & & & & & & & & & & & & & & & & & & &$	V _{FSR}	voltage on pin FSR	with respect SHR	0	14	V
$\begin{tabular}{ c c c c c } \hline V_{QLL} & voltage on pin GLR & V_{PGND} & V_{VDD} & V \\ \hline V_{QLR} & voltage on pin GLR & V_{PGND} & V_{VDD} & V \\ \hline V_{PGND} & voltage on pin PGND & 0 & 5 & V \\ \hline V_{SS(CLK)} & CLK ground supply voltage & with respect to V_{SS(CLK)} & 0 & 14 & V \\ \hline V_{DD(CLK)} & CLK supply voltage & with respect to V_{SS(CLK)} & 0 & 14 & V \\ \hline pin CLK; with respect to V_{SS(CLK)} & 0 & 14 & V \\ \hline pins RC, SU, BD, and DD & 0 & V_{VDD} & V \\ \hline SR & slew rate & pins SHL and SHR & - & 4 & V/ns \\ \hline Currents & & & & \\ \hline R_{osc} & oscillator resistance & connected between pins VDD and & 100 & - & k\Omega \\ \hline RC & & & & & \\ \hline V_{SSD} & electrostatic discharge voltage & & & & & \\ \hline HV, V_{SS(CLK)}, V_{DD(CLK)}, CLK, FSL, & - & & & \\ \hline HV, V_{SS(CLK)}, V_{DD(CLK)}, CLK, FSL, & - & & & \\ \hline other pins & - & & & & & \\ \hline other pins & - & & & & & & \\ \hline other pins & - & & & & & & \\ \hline electrostatic discharge voltage & & & & & & \\ \hline human body model: & & & & & & \\ \hline rachine model; all pins & - & & & & & & \\ \hline 0 & V & & & & & & \\ \hline 0 & V & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & & \\ \hline 0 & & & & & & & & & & & \\ \hline 0 & & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & & \\ \hline 0 & & & & & & & & & \\ \hline 0 & & & & & & & & & \\ \hline 0 & & & & & & & & & \\ \hline 0 & & & & & & & & & \\ \hline 0 & & & & & & & & & \\ \hline 0 & & & & & & & & & \\ \hline 0 & & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & \\ \hline 0 & & & & & & & \\$	V _{GHL}	voltage on pin GHL		V_{SHL}	V_{FSL}	V
$V_{\text{GLR}} \qquad \text{voltage on pin GLR} \qquad V_{\text{PGND}} \qquad V_{\text{VDD}} \qquad V_{\text{VD}} \qquad V_{\text{VDD}} \qquad V_{\text{VD}} \qquad V_{\text{VD}} \qquad V_{\text{VD}} \qquad V_{\text{VD}} \qquad V_{\text{VD}}$	V _{GHR}	voltage on pin GHR		V_{SHR}	V_{FSR}	V
$V_{PGND} voltage on pin PGND \qquad 0 \qquad 5 \qquad V \\ V_{SS(CLK)} CLK ground supply voltage \qquad 0 \qquad 5 \qquad V \\ V_{SS(CLK)} CLK supply voltage \qquad with respect to V_{SS(CLK)} \qquad 0 \qquad 14 \qquad V \\ V_{DD(CLK)} CLK supply voltage \qquad with respect to V_{SS(CLK)} \qquad 0 \qquad 14 \qquad V \\ pins RC, SU, BD, and DD \qquad 0 \qquad V_{VDD} \qquad V \\ SR \qquad slew rate \qquad pins SHL and SHR \qquad - \qquad 4 \qquad V/ns \\ \hline Currents \\ R_{osc} \qquad oscillator resistance \qquad connected between pins VDD and \\ RC \qquad \qquad RC \qquad V \\ FSD \qquad V \\ FSD \qquad electrostatic discharge voltage \qquad human body model: \\ \hline HV, V_{SS(CLK)}, V_{DD(CLK)}, CLK, FSL, \\ FSR, GHL, GHR, SHL, SHR \qquad - \qquad 2 \qquad kV \\ \hline enter pins \qquad - \qquad 2 \qquad kV \\ \hline machine model; all pins \qquad - \qquad 200 \qquad V \\ \hline \end{array}$	V _{GLL}	voltage on pin GLL		V _{PGND}	V_{VDD}	V
$\begin{split} & \begin{array}{c} V_{\text{SS}(\text{CLK})} & \begin{array}{c} \text{CLK ground supply voltage} & & \begin{array}{c} -0.9 & 14 & V \\ V_{\text{DD}(\text{CLK})} & \begin{array}{c} \text{CLK supply voltage} & & \text{with respect to } V_{\text{SS}(\text{CLK})} & \begin{array}{c} 0 & 14 & V \\ V_{\text{D}} & & \begin{array}{c} P_{\text{D}}(CLK) & \\ P_{\text{D}}(P_{\text{D}}(CLK) & \\ P_{\text{D}}(P_{\text{D}}(CLK) & \\ P_{\text{D}}(P_{\text{D}}$	V _{GLR}	voltage on pin GLR		V _{PGND}	V_{VDD}	V
$V_{DD(CLK)} = CLK supply voltage = with respect to V_{SS(CLK)} = 0 = 14 = V$ $V_{1} = input voltage = pin CLK; with respect to V_{SS(CLK)} = 0 = 14 = V$ $pin CLK; with respect to V_{SS(CLK)} = 0 = 14 = V$ $pin CLK; with respect to V_{SS(CLK)} = 0 = 14 = V$ $pin CLK; with respect to V_{SS(CLK)} = 0 = 14 = V$ $Pin CLK; with respect to V_{SS(CLK)} = 0 = 14 = V$ $V_{VDD} = V$ $Pin CLK; with respect to V_{SS(CLK)} = 0 = 14 = V$ $V_{VDD} = V$ $Pin CLK; with respect to V_{SS(CLK)} = 0 = V$ $V_{VDD} = V$ $V_{VDD} = V$ $Pin SHL and SHR = - 4 = V/ns$ $Currents$ $R_{osc} = oscillator resistance = connected between pins VDD and RC = 100 = - V$ $Pin SRC, SU, BD, and DD = 0 = V$ $Pin SHL and SHR = - 4 = V/ns$ $Pin CLK; with respect to V_{SS(CLK)}, V_{DD} = 0$ $Pin CLK; with respect to V_{SS(CLK)}, Pin CLK; with respect to V_{SS}$ $Pin CLK;$	V _{PGND}	voltage on pin PGND		0	5	V
$V_{I} \qquad input voltage \qquad pin CLK; with respect to V_{SS(CLK)} \qquad 0 \qquad 14 \qquad V$ $pins RC, SU, BD, and DD \qquad 0 \qquad V_{VDD} \qquad V$ $SR \qquad slew rate \qquad pins SHL and SHR \qquad - \qquad 4 \qquad V/ns$ $Currents$ $R_{osc} \qquad oscillator resistance \qquad connected between pins VDD and RC \qquad 100 \qquad - \qquad k\Omega$ $ESD \qquad V$ $V_{ESD} \qquad electrostatic discharge voltage \qquad human body model: \qquad V V_{SS(CLK)}, V_{DD(CLK)}, CLK, FSL, SHR \qquad - \qquad 2 \qquad kV$ $respective results res$	V _{SS(CLK)}	CLK ground supply voltage		-0.9	14	V
$\begin{tabular}{ c c c c c } \hline $pins RC, SU, BD, and DD & 0 & V_{VDD} & V \\ \hline SR slew rate $pins SHL and SHR$ 4 & V/ns$ \\ \hline $Currents$ \\ \hline $Currents$ \\ \hline R_{osc} oscillator resistance $connected between pins VDD and R_{C} & 100 & $-$ K \\ \hline ESD \\ \hline V_{ESD} electrostatic discharge voltage $human body model:$ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $	V _{DD(CLK)}	CLK supply voltage	with respect to $V_{SS(\text{CLK})}$	0	14	V
SRslew ratepins SHL and SHR-4V/nsCurrentsRoscoscillator resistanceconnected between pins VDD and RC100-kΩESDVESDelectrostatic discharge voltagehuman body model: HV, V _{SS(CLK)} , V _{DD(CLK)} , CLK, FSL, FSR, GHL, GHR, SHL, SHR-900Vother pins-2kVmachine model; all pins-200V	VI	input voltage	pin CLK; with respect to $V_{\text{SS}(\text{CLK})}$	0	14	V
Currents connected between pins VDD and RC 100 - kΩ ESD vESD electrostatic discharge voltage human body model: - <t< td=""><td></td><td></td><td>pins RC, SU, BD, and DD</td><td>0</td><td>V_{VDD}</td><td>V</td></t<>			pins RC, SU, BD, and DD	0	V_{VDD}	V
Roscoscillator resistanceconnected between pins VDD and RC100-kΩESDelectrostatic discharge voltagehuman body model:900VHV, V _{SS(CLK)} , V _{DD(CLK)} , CLK, FSL, FSR, GHL, GHR, SHL, SHR-200Vother pins-200V	SR	slew rate	pins SHL and SHR	-	4	V/ns
RC ESD V _{ESD} electrostatic discharge voltage HV, V _{SS(CLK)} , V _{DD(CLK)} , CLK, FSL, FSR, GHL, GHR, SHL, SHR - 900 V other pins - 2 kV machine model; all pins - 200 V	Currents					
VESD electrostatic discharge voltage human body model: 900 V HV, V _{SS(CLK)} , V _{DD(CLK)} , CLK, FSL, FSR, GHL, GHR, SHL, SHR - 900 V other pins - 2 kV machine model; all pins - 200 V	R _{osc}	oscillator resistance	•	100	-	kΩ
HV, V _{SS(CLK)} , V _{DD(CLK)} , CLK, FSL, FSR, GHL, GHR, SHL, SHR900Vother pins-2kVmachine model; all pins-200V	ESD					
FSR, GHL, GHR, SHL, SHRother pins-2kVmachine model; all pins-200V	V _{ESD}	electrostatic discharge voltage	human body model:			
machine model; all pins - 200 V			HV, V _{SS(CLK)} , V _{DD(CLK)} ,CLK, FSL, FSR, GHL, GHR, SHL, SHR	-	900	V
			other pins	-	2	kV
charged device model; all pins - 500 V			machine model; all pins	-	200	V
			charged device model; all pins	-	500	V

9. Thermal characteristics

Table 5.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	100	K/W

10. Characteristics

Table 6.Characteristics

 $T_j = 25 \circ C$; all voltages are measured with respect to signal ground (pin 14); currents are positive when flowing into the IC, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Uni
High voltage						
l _{leak}	leakage current	pin HV; I _{HV} (V _{HV} = 565 V) – I _{HV} (V _{HV} = 500 V)	-	-	5	μA
		pin FSL; $V_{FSL} = V_{SHL} = V_{GHL} = 564 \text{ V}$	-	-	5	μA
		pin FSR; V _{FSR} = V _{SHR} = V _{GHR} = 564 V	-	-	5	μA
Start-up via HV	' pin					
I _{I(HV)}	input current on pin HV	V _{HV} = 80 V	-	590	825	μA
V _{startup(HV)}	start-up voltage on pin HV		11.3	13.2	14.7	V
V _{UVLO(HV)}	undervoltage lockout voltage on pin HV		8.6	10.7	12.2	V
V _{hys}	hysteresis voltage		2	2.5	3	V
V _{VDD}	voltage on pin VDD	V _{HV} = 20 V	10.5	12	13.5	V
Start-up via VD	D pin					
I _{I(VDD)}	input current on pin VDD	V _{VDD} = 8.25 V	-	500	800	μA
V _{startup} (VDD)	start-up voltage on pin VDD		8.25	9.0	9.75	V
V _{UVLO(VDD)}	undervoltage lockout voltage on pin VDD		5.75	6.5	7.25	V
V _{hys}	hysteresis voltage		2	2.5	3	V
gate drivers						
R _{on}	on-state resistance	GHR and GHL drivers; $V_{FSL} = V_{FSR} = 12 V;$ $V_{SHL} = V_{SHR} = 0 V;$ $I_{GHL} = I_{GHR} = -50 mA$	-	20	42	Ω
		GLR and GLL drivers; V _{VDD} = 12 V; V _{PGND} = 0 V; I _{GLL} = I _{GLR} = -50 mA	-	20	42	Ω
R _{off}	off-state resistance	GHR and GHL drivers; $V_{FSL} = V_{FSR} = 12 V;$ $V_{SHL} = V_{SHR} = 0 V;$ $I_{GHL} = I_{GHR} = 50 mA$	-	12	26	Ω
		GLR and GLL drivers; V_{VDD} = 12 V; V_{PGND} = 0 V; I_{GLL} = I_{GLR} = 50 mA	-	12	26	Ω

Table 6. Characteristics ...continued

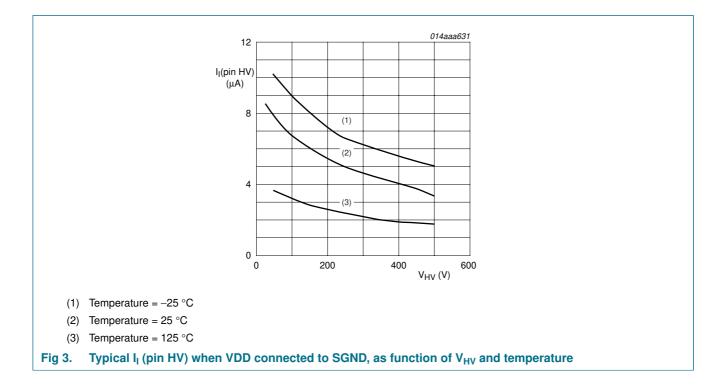
 $T_j = 25 \circ C$; all voltages are measured with respect to signal ground (pin 14); currents are positive when flowing into the IC, unless otherwise specified.

		Тур	Max	Unit
$ I_{O(source)} \qquad \mbox{output source current} \qquad V_{FSL} = V_{FSR} = V_{VDI} \\ V_{SHL} = V_{SHR} = 0 \ V; \\ V_{GHL} = V_{GHR} = V_{GH} $	L = V _{GLR} = 8 V	200	-	mA
$ I_{O(sink)} \qquad \mbox{output sink current} \qquad V_{FSL} = V_{FSR} = V_{VDI} \\ V_{SHL} = V_{SHR} = 0 \ V; \\ V_{GHL} = V_{GHR} = V_{GL} $		200	-	mA
$V_{d(bs)}$ bootstrap diode voltage current on diode =	20 mA -	2.3	-	V
t _{no} non-overlap time	-	80	250	ns
V _{UVLO} undervoltage lockout high side driver voltage	-	4.0	5.5	V
$I_{FS} \qquad \mbox{ current on pin FS} \qquad V_{FSL} = V_{FSR} = 12 \ V_{SHL} = V_{SHR} = 0 \ V_{SHR} = 0 \ V_{SHL} = V_{SHR} = 0 \ V_{S$	/; 2	4	6	μA
DD input				
V _{IH(DD)} HIGH-level input voltage V _{VDD} = 12 V on pin DD	6	4.5	-	V
$V_{IL(DD)}$ LOW-level input voltage on $V_{VDD} = 12 V$ pin DD	-	-	3	V
I_I input current $V_{VDD} = 12 V$	-	0	1	μA
SU input				
$V_{startup}$ start-up voltage $V_{VDD} = 12 V$	1	1.3	1.5	V
V_{hys} hysteresis voltage $V_{VDD} = 12 V$	-	100	-	mV
I_I input current $V_{VDD} = 12 V$	-	0	1	μA
CLK input				
$V_{IH(CLK)}$ HIGH-level input voltage $V_{SS(CLK)} = 0 V; V_{DE}$ on pin CLK	_{D(CLK)} = 12 V 0.9	1.6	2.7	V
$V_{hys} \qquad \qquad hysteresis \ voltage \qquad \qquad V_{SS(CLK)} = 0 \ V; \ V_{DD}$	о _(СLК) = 12 V -	100	-	mV
I ₁ input current	-	0	1	μA
f_{bridge} bridge frequency $V_{RC} = 0 V$	-	-	250	kHz
supply for CLK				
$I_{DD(CLK)} \qquad \qquad CLK \text{ supply current} \qquad \qquad V_{SS(CLK)} = 0 \ V; \ V_{DD}$	_{O(CLK)} = 14 V -	420	625	μA
$V_{DD(CLK)}$ CLK supply voltage $V_{SS(CLK)} = 0 V$	5.75	-	14	V
BD input				
V _{BD} voltage on pin BD	1.23	1.29	1.35	V
I ₁ input current	-	0	1	μA
Internal oscillator				
$f_{osc(int)}$ internal oscillator $V_{CLK} = 0 V; V_{SS(CLK)}$ frequency	₍₎ = 0 V -	-	100	kHz
K_{osc} oscillator constant $f_{bridge} = 500 \text{ Hz}$	0.89	0.97	1.05	

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11. Package outline

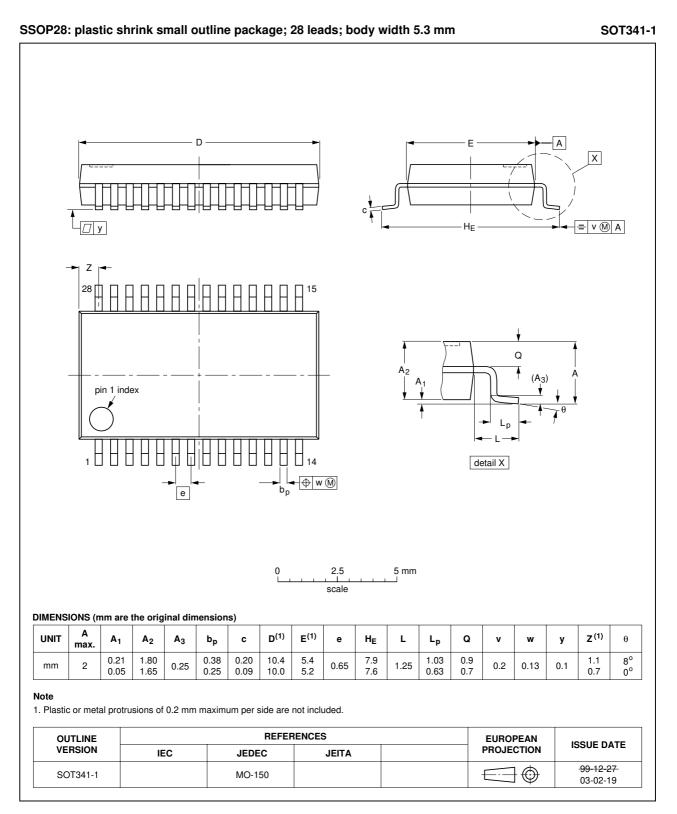


Fig 4. Package outline SSOP28 (SOT341-1)

12. Revision history

Table 7. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
UBA2035_1	20081031	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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15. Contents

1	General description 1
2	Features 1
3	Applications 1
4	Ordering information 1
5	Block diagram 2
6	Pinning information
6.1	Pinning
6.2	Pin description 3
7	Functional description 4
7.1	Supply voltage 4
7.2	Start-up 4
7.3	Oscillation state 4
7.4	Non-overlap time 5
7.5	Start-up delay 5
7.6	Bridge disable 6
8	Limiting values
9	Thermal characteristics7
10	Characteristics7
11	Package outline 10
12	Revision history 11
13	Legal information 12
13.1	Data sheet status 12
13.2	Definitions 12
13.3	Disclaimers 12
13.4	Trademarks 12
14	Contact information 12
15	Contents

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